

MDT0390A6IH-RGB	480 x 128	RGB Interface	TFT Module		
		Specification			
Version: 1		Date: 10/02/2022			
Revision					
1 08	/02/2022	First issue			

Display F	eatures		
Display Size	3.90"		
Resolution	480 x 128		
Orientation	Landscape		
Appearance	RGB		
Logic Voltage	3V		oHS
Interface	RGB		
Brightness	500 cd/m ²		moliont
Touchscreen		1 00	mpnant
Module Size	105.50 x 37.00 x 3.05mm		1.22
Operating Temperature	-30°C ~ +85°C		
Pinout	40 way FFC	Box Quantity	Weight / Display
Pitch	0.5mm	Ing - cin	nnlv

* - For full design functionality, please use this specification in conjunction with the SC7283 specification.(Provided Separately)

Display Accessories					
Part Number	Description				
MPBV6	40 Way FFC to cable and wires. Driven by any driver board that can be wired to a 1mm pitch SHDR-40V-S-B receptacle.				
MDIB-11	The MDIB-11 is an HDMI to RGB converter. Ideal for connecting a range of Midas TFT displays to a Single Board Computer such as the Raspberry Pi.				

Optional Varian	Its
Appearances	Voltage

Summary

3.9" is a color active matrix thin film transistor (TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. This TFT LCD has a 3.9 inch diagonally measured active display area with 480x128 (480 horizontal by 128 vertical pixel) resolution.

General Specifications

- Size: 3.9 inch
- Dot Matrix: 480 x RGBx128(TFT) dots
- Module dimension: 105.5(W) x 37.0(H) x 3.05(D) mm
- Active area: 95.04 x 25.34 mm
- Pixel pitch: 0.198 x 0.198 mm
- LCD type; TFT, Normally Black, Transmissive
- Viewing Angle: 80/80/80/80
- Aspect Ratio: Bar Type
- TFT Driver IC: SC7283 or equivalent
- Interface: 24-bit RGB
- Backlight Type: LED,Normally White
- With /Without TP: Without TP
- Surface: Anti-Glare

*Color tone slight changed by temperature and driving voltage.

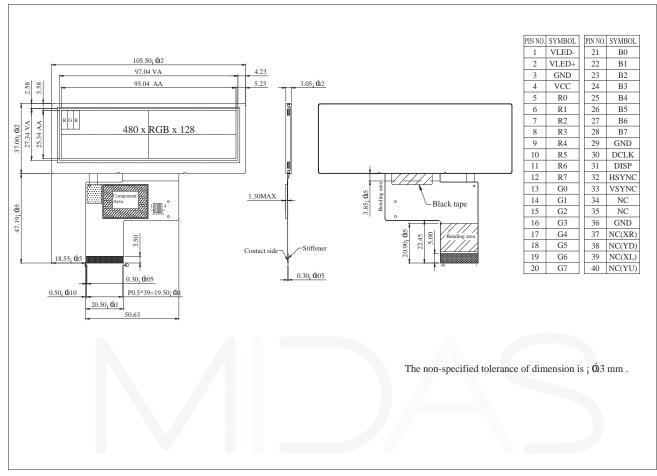
Interface 1. LCM PIN Definition

I. LCM PIN Definition							
Pin	Symbol	Function	Remark				
1	VLED-	Power for LED backlight cathode					
2	VLED+	Power for LED backlight anode					
3	GND	Power ground					
4	VCC	Power voltage					
5	R0	Red data					
6	R1	Red data					
7	R2	Red data					
8	R3	Red data					
9	R4	Red data					
10	R5	Red data					
11	R6	Red data					
12	R7	Red data					
13	G0	Green data					
14	G1	Green data					
15	G2	Green data					
16	G3	Green data					
17	G4	Green data					
18	G5	Green data	ply				
19	G6	Green data					
20	G7	Green data					
21	B0	Blue data					
22	B1	Blue data					
23	B2	Blue data					
24	B3	Blue data					
25	B4	Blue data					
26	B5	Blue data					
27	B6	Blue data					
28	B7	Blue data					
29	GND	Power ground					
30	DCLK	Pixel clock input pin					
31	DISP	DISP sets the display mode.					

		DISP	Function Description	
		L	Standby mode	
		н	Normal display mode	
32	HSYNC	Horizontal sy	nc signal, default is negative polarity.	
33	VSYNC	Vertical sync	signal, default is negative polarity.	
34	NC	No connection	on	
35	NC	No connection	on	
36	GND	Power groun	d	
37	NC(XR)	No connection	on	
38	NC(YD)	No connection	on	
39	NC(XL)	No connection	on	
40	NC(YU)	No connectio	n	

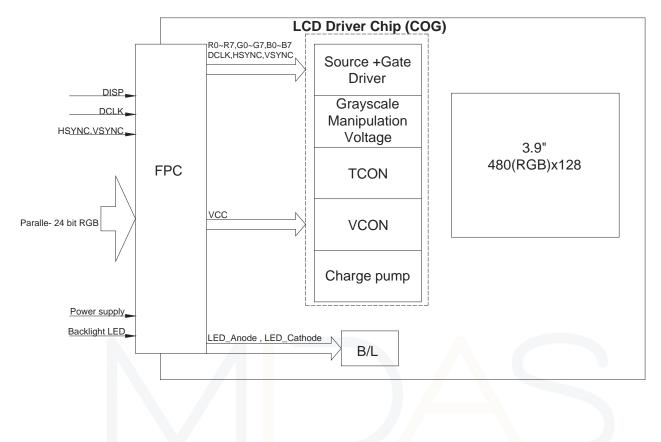


Contour Drawing



design • manufacture • supply

Block Diagram



design • manufacture • supply

Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	TOP	-30		+85	°C
Storage Temperature	TST	-30		+85	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above 1.

Electrical Characteristics

1. Operating conditions:

Item	Symbol	Min	Тур	Max	Unit	Remark
Supply Voltage For LCM	VCC	3.0	-	3.6	V	
Supply Current For LCM	ICC	-	20	30	mA	Note1

Note 1 : This value is test for VCC=3.3V , Ta=25 °C only

2. LED driving conditions

2. LED driving condition		=3.3V, Ta=	=25 C 011	y		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Remark
LED current	-	-	40	-	mA	-
Power Consumption	in -	560	600	680	mW	vlad
LED voltage	VLED+	14	15	17	V	Note 1
LED Life Time	-	-	50,000	-	Hr	Note 2,3,4

Note 1 : There are 1 Groups LED



CIRCUIT DIAGRAM

Note 2 : Ta = 25 °C

Note 3 : Brightness to be decreased to 50% of the initial value

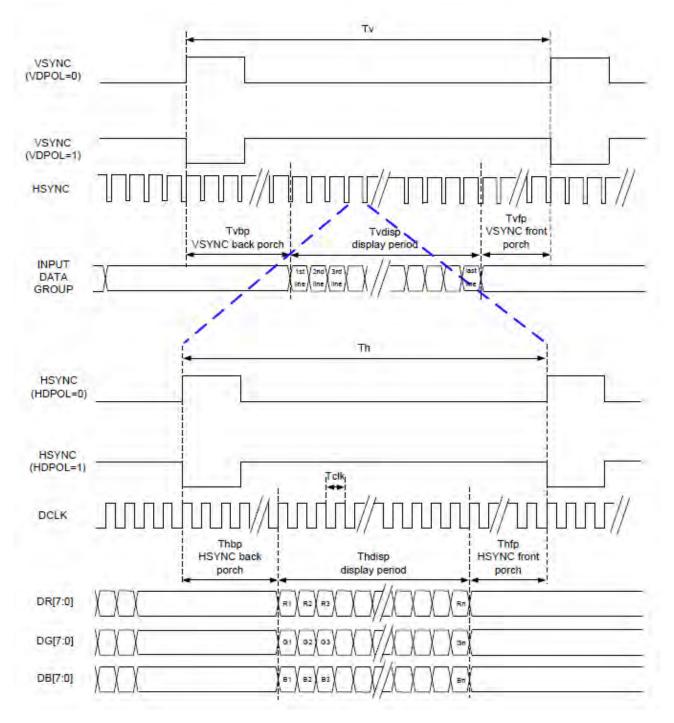
Note 4 : The single LED lamp case

Temp. ≦60°C, 90% RH MAX. Temp. >60°C, Absolute humidity shall be less than 90% RH at 60°C

AC Characteristics

AC Electrical Characteristics (VCC= 3.3V, GND= 0V, TA=25°C)

1. RGB Interface SYNC Mode

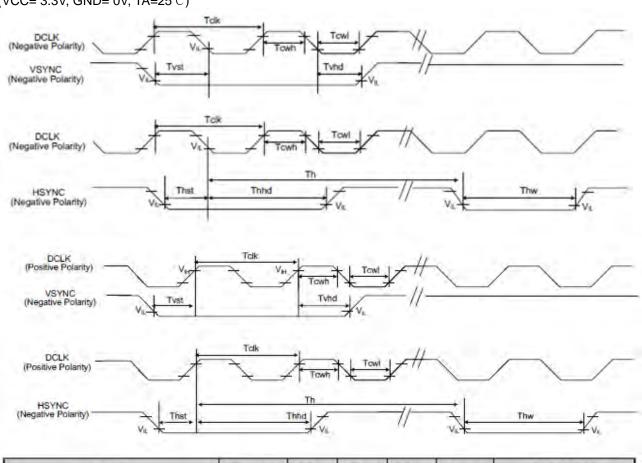


480RGB X 272 Resolution Timing Table								
Item		Symbol	Min.	тур.	Max.	Unit	Remark	
DCL	K Frequency	Fclk	8	9	12	MHz		
DC	LK Period	Tclk	83	111	125	ns		
	Period Time	Th	485	531	598	DCLK		
HSYNC	Display Period	Thdisp		480		DCLK		
	Back Porch	Thbp	3	43	43	DCLK	Thbp of SYNC mode set by H_BLANKING[7:0]	
	Front Porch	Thfp	2	8	75	DCLK		
	Pulse Width	Thw	2	4	43	DCLK		
	Period Time	Tv	276	292	321	HSYNC		
	Display Period	Tvdisp	-	272		HSYNC		
VSYNC	Back Porch	Tvbp	2	12	12	HSYNC	Tvbp of SYNC mode set by V_BLANKING[7:0]	
	Front Porch	Tvfp	2	8	37	HSYNC	P	
	Pulse Width	Tvw	2	4	12	HSYNC		

2. Parallel 24 bit RGB Input Timing Table (Parallel 24-bit RGB Input Timing (VCC= 3.3V, GND= 0V, TA=25°C)

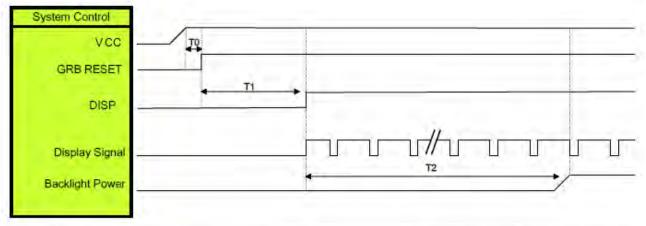
Note: It is necessary to keep Tvbp =12 and Thbp =43 in sync mode. DE mode is unnecessary to keep it.

3. System Bus Timing for RGB Interface (VCC= 3.3V, GND= 0V, TA=25 $^\circ\!\!\mathrm{C}$)



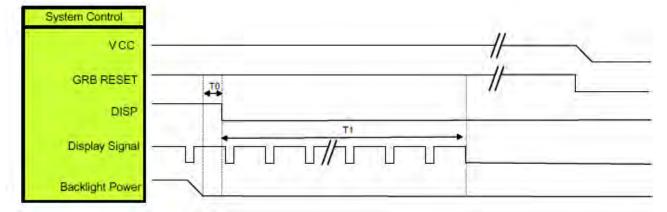
Item	Symbol	Min.	Тур.	Max.	Unit	Conditions
CLK Pulse Duty	Tcw	40	50	60	%	
HSYNC Width	Thw	2	~	1.9	DCLK	
VSYNC Setup Time	Tvst	12	1.41	114.1	ns	
VSYNC Hold Time	Tvhd	12	1.4		ns	
HSYNC Setup Time	Thst	12		-	ns	
HSYNC Hold Time	Thhd	12	4	-	ns	
Data Setup Time	Tdsu	12	-	2	ns	
Data Hold Time	Tdhd	12			ns	

Power sequence 1. Power On Sequence



Symbol	Description	Min, Time	Unit
то	System power stability to GRB RESET signal	0	ms
T1	GRB RESET= "High" to DISP="High"	10	ms
T2	Display Signal output to Backlight Power on	250	ms

2. Power Off Sequence



Symbol	Description	Min. Time	Unit
то	Backlight Power off to DISP="Low"	5	ms
T1	DISP="Low" to IC internal voltage discharge complete	80	ms

Item		Symbol	Condition.	Min	Тур.	Max.	Unit	Remark
Response time		Tr+ Tf	θ=0°、Φ=0°	-	30	40	ms	Note 3
Contrast ratio		CR	At optimized viewing angle	640	800	-	-	Note 4
Color	White	Wx	θ=0°、Φ=0	0.27	0.32	0.37	-	Note
Chromaticity		Wy		0.295	0.345	0.395	-	2,6,7
	Hor. Ver.	ΘR	CR≧10	70	80	-	Deg.	Note 1
Viewing		ΘL		70	80	-		
angle		ΦΤ		70	80	-		
		ΦВ		70	80	-		
Brightness		-	-	400	500	-	cd/m ²	Center of display
Uniformity		(U)	-	75	-	-	%	Note 5

Optical Characteristics

Ta=25±2°C

Note 1: Definition of viewing angle range

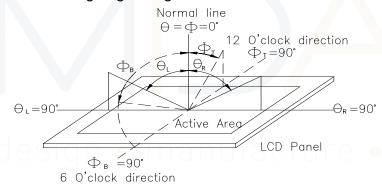
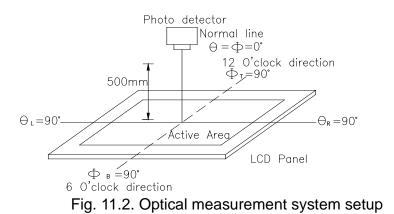


Fig. 11.1. Definition of viewing angle

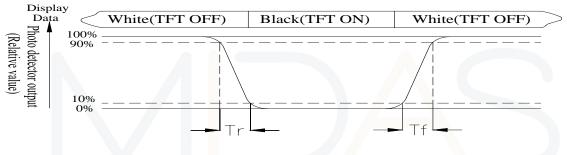
Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7orBM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.



Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, Tr, is the time between photo detector output intensity changed from 90% to 10%. And fall time, Tf, is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

Contrast ratio (CR) = Luminance measured when LCD on the "White" state Luminance measured when LCD on the "Black" state

Note 5: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (reference the picture in below). Every measuring point is placed at the center of each measuring area. Luminance Uniformity (U) = Lmin/Lmax x100% L = Active area length W = Active area width

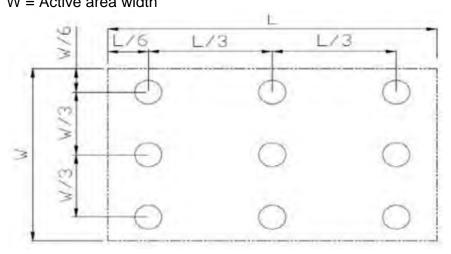


Fig 11.3. Definition of uniformity

Note 6: Definition of color chromaticity (CIE 1931) Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

Reliability

Content of Reliability Test (Super Wide temperature, -30°C~85°C)

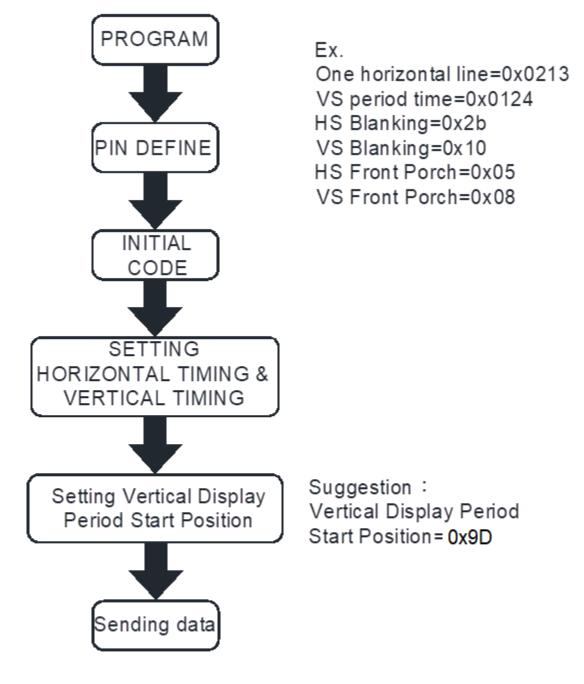
Test Item	Content of Test	Test Condition	Note 2	
High Temperature	Endurance test applying the high storage temperature	85°C		
storage	for a long time.	200hrs		
Low Temperature	Endurance test applying the low storage temperature	-30°C	1,2	
storage	for a long time.	200hrs		
High Temperature	Endurance test applying the electric stress (Voltage &	85°C		
Operation	Current) and the thermal stress to the element for a	200hrs		
•	long time.			
Low Temperature	Endurance test applying the electric stress under low	-30°C	1	
Operation	temperature for a long time.	200hrs		
High Temperature/	The module should be allowed to stand at	60°C,90%RH	1,2	
Humidity storage	60°C,90%RH max	96hrs	ľ	
Thermal shock	The sample should be allowed stand the following 10	-30°C/85°C		
resistance	cycles of	10 cycles		
	operation	,		
	-30°C 25°C 85°C			
	30min 5min 30min			
	1 cycle			
Vibration test	Endurance test applying the vibration during	Total fixed		
	transportation and using.	amplitude : 1.5mm		
		Vibration Frequency :		
		10~55Hz		
		One <mark>cyc</mark> le 60		
		seconds to 3		
		directions of		
		X,Y,Z for Each 15		
		minutes		
Static electricity test	Endurance test applying the electric stress to the	VS=±600V(contact)	V.	
	terminal.	,±800v(air),	y	
		RS=330Ω		
		CS=150pF		
		10 times		

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

Display start address setting



Note :

For different Controller ICs, the value of vertical display period start position need to be adjusted accordingly.